Beam Power Tube

CERAMIC-METAL SEALS UNIPOTENTIAL CATHODE CONDUCTION COOLED

Electrical:

COAXIAL-ELECTRODE STRUCTURE INTEGRAL CONDUCTION CYLINDER 180 WATTS CW INPUT UP TO 1215 Mc

For Use at Frequencies up to 2000 Mc

GENERAL DATA

Electrical:	
Heater, for Unipotential Cathode:	
	olts
Current at heater volts = $6.32.1$	amp
Minimum heating time 60	sec
Mu-Factor, Grid No.2 to Grid No.1	
for plate volts = 250, grid-No.2	
volts = 250, and plate ma. = 100 18	
Direct Interelectrode Capacitances:	_
Grid No.1 to plate 0.065 max.	$\mu\mu f$
Grid No.1 to cathode & heater 14 Plate to cathode & heater 0.015 max.	μμf μμf
Grid No.1 to grid No.2	μμτ
Grid No.2 to plate 4.4	$\mu\mu$ f
Grid No.2 to cathode & heater 0.4 max.	$\mu\mu$ f
	اس
Mechanical:	
Operating Position	Any
Overall Length 1.885" + 0.070" - 0.	080"
Greatest Diameter (See Dimensional Outline) 1.	119
	2 oz
Socket:	
For frequencies up to about 400 Mc For use at higher frequencies See Mounting Arrange	
	ment
Terminal Connections (See Dimensional Outline):	
Terminal Connections (See Dimensional Outline): G_I - Grid-No.1- H,K - Heater-	- &
Terminal Connections (See Dimensional Outline): G_1 - Grid-No.1- Terminal P Cathoo	- & le-
Terminal Connections (See Dimensional Outline): G ₁ - Grid-No.1- Terminal P Cathod Contact Termin	- & le- nal
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Contact Surface. Terminal Contact	- & le- lal :t
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Contact Surface. G ₂ - Grid-No.2- Surface	- & le- lal :t
Terminal Connections (See Dimensional Outline): G_I - Grid-No.1- Terminal Contact Surface. G_2 - Grid-No.2- Terminal G_2 Terminal G_3 Terminal G_4 Terminal G_7 Terminal G_8 Terminal G_8 Terminal G_9	- & le- lal :t
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface. G ₂ - Grid-No.2- Terminal Contact Contact Terminal Contact Terminal Contact Terminal Contact Terminal Contact Terminal Contact	- & le- nal :t :e
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface. G ₂ - Grid-No.2- Terminal Contact Surface Gontact Surface Terminal Contact Surface Terminal Contact Surface Terminal Contact Surface	- & le- lal et ee
Terminal Connections (See Dimensional Outline): G_I - Grid-No.1- Terminal Contact Surface. G_2 - Grid-No.2- Terminal Contact Surface H - Heater- G_2 - Grid-No.2- Terminal Contact Surface H - Heater-	- & le- lal et ee
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface. G ₂ - Grid-No.2- Terminal Contact Surface Gontact Surface Terminal Contact Surface Terminal Contact Surface Terminal Contact Surface	- & le- lal et ee
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Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface G ₂ - Grid-No.2- Terminal Contact Surface H - Heater- Terminal Contact Surface Surface Surface Surface Surface Surface Surface Surface Surface	- & le- lal et ee
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface G ₂ - Grid-No.2- Terminal Contact Surface H - Heater- Terminal Contact Surface Touthor Terminal Contact Surface Terminal Contact Surface Thermal:	- & de- nal de e e aal de
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface G ₂ - Grid-No.2- Terminal Contact Surface H - Heater- Terminal Contact Surface Terminal Contact Surface Therminal Contact Surface Thermal: Conduction-Cylinder Temperature	- & le- lal et ee
Terminal Connections (See Dimensional Outline): G_I - Grid-No.1- Terminal Contact Surface G_2 - Grid-No.2- Terminal Contact Surface H - Heater- Terminal Contact Surface H - Heater- Terminal Contact Surface Terminal Contact Surface Terminal Contact Surface Terminal Contact Surface Surface Thermal: Conduction-Cylinder Temperature	- & le- le- lal et ee hal et
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface G ₂ - Grid-No.2- Terminal Contact Surface H - Heater- Terminal Contact Surface Surface Terminal Contact Surface Surface Terminal Contact Surface Surface Terminal Contact Surface Surface Surface Terminal Contact Surface Surface Surface Surface Surface Terminal Contact Surface	- & de- nal de e e aal de
Terminal Connections (See Dimensional Outline): G_{ } - Grid-No.1-	- & le- leal et lee leal et ee
Terminal Connections (See Dimensional Outline): G _I - Grid-No.1- Terminal Contact Surface G ₂ - Grid-No.2- Terminal Contact Surface H - Heater- Terminal Contact Surface Surface Terminal Contact Surface Surface Terminal Contact Surface Surface Terminal Contact Surface Surface Surface Terminal Contact Surface Surface Surface Surface Surface Terminal Contact Surface	- & le- leal let leal let lee leal let lee lee lee lee lee lee lee lee le

- Indicates a change.

value of $250^{\rm O}$ C. The plate, grid-No.2, grid-No.1, cathode, and heater terminals may also require coupling to the heat sink to limit their respective seal temperature to the specified maximum value of $250^{\rm O}$ C.

specified maximum value of 250 C.	
AT DOUGH MADILETED & MODULATOR AT AD	
AF POWER AMPLIFIER & MODULATOR Class AB	
Maximum CCS Ratings, Absolute-Naximum Values:	
DC PLATE VOLTAGE	volts
DC GRID-No.2 VOLTAGE	volts ma
MAX.—SIGNAL PLATE INPUT	
DC GRID-No.2 VOLTAGE	watts
PLATE DISSIPATION	
Typical CCS Push-Pull Operation:	
Values are for 2 tubes	
DC Plate Voltage 650 850	volts
DC Plate Voltage	volts
DC Grid-No.1 Voltage from fixed-bias source15 -15	volts
Peak AF Grid-No.1-to-Grid-No.1 Voltage# 30 30	
Zero-Signal DC Plate Current 80 80	ma
MaxSignal DC Plate Current	ma ma
Man Simple DC Crid No. 2 Current 20 20	ma
Effective Load Resistance (Plate to plate). 4330 7000	ohms
Max.—Signal Driving Power (Approx.) 0 0	
MaxSignal Power Öutput (Approx.) 50 80	watts
Maximum Circuit Values:	
Grid-No.1-Circuit Resistance under any condition:*	
For fixed-hias operation 30000 max.	ohms
For cathode-bias operation Not recor	mended
AF POWER AMPLIFIER & MODULATOR — Class AB2*	
Maximum CCS Ratings, Absolute-Maximum Values:	
DC PLATE VOLTAGE 1000 max.	volts
DC GRID-No.2 VOLTAGE 300 max.	volts
MAXSIGNAL DC PLATE CURRENT 180 max.	
MAXSIGNAL DC GRID-No.1 CURRENT 30 max.	
MAX.—SIGNAL PLATE INPUT	watts
MAX.—SIGNAL GRID—No.2 INPUT 7 max. PLATE DISSIPATION 7	walts
Typical CCS Push-Pull Operation:	
Values are for 2 tubes	
DC Plate Voltage	
DC Grid-No.2 Voltage 300 300 DC Grid-No.1 Voltage from fixed-bias source15 -15	volts volts
Peak AF Grid-No.1-to-Grid-No.1 Voltage 46 46	
Zero-Signal DC Plate Current 80 80	
MaxSignal DC Plate Current 355 355	
maxdigital be reace current	ma

MaxSignal DC Grid-No.2 Current	watt						
LINEAR RF POWER AMPLIFIER							
Single-Sideband Suppressed-Carrier Service							
Maximum CCS Ratings, Absolute-Maximum Values:							
Up to 1215 Mc							
DC PLATE VOLTAGE 1000 max. DC GRID-No.2 VOLTAGE 300 max.	volts volts						
MAX.—SIGNAL DC PLATE CURRENT	ma						
MAXSIGNAL DC GRID-No.1 CURRENT 30 max.	ma						
MAXSIGNAL PLATE INPUT 180 max.	watts						
MAX.—SIGNAL GRID—No.2 INPUT 7 max. PLATE DISSIPATION	watts						
•							
Typical CCS Class AB "Single-Tone" Operation:							
Up to 60 Mg							
DC Plate Voltage 650 850 DC Grid-No.2 Voltage 300 300							
DC Grid-No.2 Voltage 300 300 DC Grid-No.1 Voltage15 -15	volts						
Zero-Signal DC Plate Current 40 40	ma						
Zero-Signal DC Grid-No.2 Current 0 0	ma						
Effective RF Load Resistance 2165 3500 MaxSignal DC Plate Current 100 100	ohms ma						
MaxSignal DC Grid-No.2 Current 10 10	ma						
MaxSignal DC Grid-No.1 Current 0 0	ma						
MaxSignal Peak RF Grid-No.1 Voltage 15 15	volts						
MaxSignal Driving Power (Approx.) 0 0 MaxSignal Power Output (Approx.) 25 40	watts watts						
	Watts						
Maximum Circuit Values:							
Grid-No.1-Circuit Resistance under any condition:							
For fixed-bias operation 30000 max. For cathode-bias operation Not recor	ohms mended						
Tor eachough trans operations	· · · · · · · · · · · · · · · · · · ·						
PLATE-MODULATED RF POWER AMPLIFIER - Class C Telepi	non v						
Carrier conditions per tube for use	,						
with a maximum modulation factor of 1							
Maximum CCS Ratings, Absolute-Naximum Values:							
Up to 1215 Mc							
DC PLATE VOLTAGE 800 max.	volts						
DC GRID-No.2 VOLTAGE	volts						
DC GRID-No.1 VOLTAGE	volts						
DC GRID-No.1 CURRENT 30 max.	ma ma						
PLATE INPUT 120 max.	watts						
GRID-No.2 INPUT 4.6 max.	watts						
PLATE DISSIPATION							

Typical CCS Operation:	
DC Grid-No.2 Voltage\$ 200 250 DC Grid-No.1 Voltage\$ -20 -50 DC Plate Current 100 130 DC Grid-No.2 Current 5 10 DC Grid-No.1 Current 5 10 Driver Power Output (Approx.) 2 3	volts volts volts ma ma watts watts
Maximum Circuit Values:	
Grid-No.1-Circuit Resistance under any condition	ohms
RF POWER AMPLIFIER & OSCILLATOR — Class C Telegraph and	y▲▲
RF POWER AMPLIFIER — Class C FM Telephony	
Maximum CCS Ratings, Absolute-Maximum Values:	
Up to 1215 Mc	
DC PLATE VOLTAGE. 1000 max. DC GRID-No.2 VOLTAGE. 300 max. DC GRID-No.1 VOLTAGE. -100 max. DC PLATE CURRENT. 180 max. DC GRID-No.1 CURRENT. 30 max. PLATE INPUT. 180 max. GRID-No.2 INPUT 7 max. PLATE DISSIPATION	volts volts volts ma ma watts watts
Typical CCS Operation:	
• • • • • • • • • • • • • • • • • • • •	
At 400 Mc At 1215 Mc DC Plate Voltage. 400 900 900 DC Grid-No.2 Voltage. 200 300 300 DC Grid-No.1 Voltage. -35 -30 -22 DC Plate Current. 150 170 170 DC Grid-No.2 Current. 5 1 1 DC Grid-No.1 Current. 3 10 4 Driver Power Output (Approx.) 3 3 5 Useful Power Output (Approx.) 23 80 40	volts volts volts ma ma watts
Maximum Circuit Values:	
Grid-No.1-Circuit Resistance under any condition	ohms
Because the cathode is subjected to considerable back bombardm the frequency is increased with resultant increase in temperatur heater voltage should be reduced depending on operating conditio frequency to prevent overheating the cathode and resultant short. * For socket to be used with the 7844, consult manufacturers st J-Y-M Microwave Company, 9300 West 47th Street, Brookfield, 111 E.F. Johnson Company, Naseca, Minnestota; and Collins Radio Cor 855 35th Street North, Cedar Rapids, lowa; and Jettron Products, 10, Manover, New Jersey. * Subscript 1 indicates that grid-No.1 current does not flow duripart of the input cycle.	e, the ns and life. uch as inois; mpany, Route



Continuous Commercial Service.

Averaged over any audio-frequency cycle of sine-wave form,

Maximum plate dissipation is a function of the maximum plate input, efficiency of the class of service, and the effectiveness of the cooling system. See Cooling, Conduction under General Data, and also Cooling Considerations.

Preferably obtained from a fixed supply.

The driver stage should be capable of supplying the No.1 grids of the Class AB_1 stage with the specified driving voltage at low distortion. The resistance introduced into the grid-No.1 circuit by the input coupling should be held to a low value. In no case shouldit exceed the specified maximum value. Transformer- or impedance-coupling devices are recommended.

Subscript 2 indicates that grid-No.1 current flows during some part

of the input cycle.

Driver stage should be capable of supplying the specified driving power at low distortion to the No.1 grids of the AB2 stage. To minimize distortion, the effective resistance per grid-No.1 circuit of the AB2 stage should be held at a low value. For this purpose, the use of transformer coupling is recommended.

"Single-Tone" operation refers to that class of amplifier service in which the grid-No.1 input consists of a monofrequency rf signal having constant amplitude. This signal is produced in a single-sideband suppressed-carrier system when a single audio frequency of constant amplitude is applied to the input of the system.

Obtained preferably from a separate source modulated along with the

plate supply.

Obtained from grid-No.1 resistor or from a combination of grid-No.1 resistor with either fixed supply or cathode resistor.

The driver stage is required to supply tube losses and rf-circuit losses. It should be designed to provide an excess of power above the indicated values to take care of variations in line voltage, components, initial tube characteristics, and tube characteristics during life.

If this value is insufficient to provide adequate bias, the additional required bias must be supplied by a cathode resistor or fixed supply. Key-down conditions per tube without amplitude modulation. Amplitude modulation essentially negative may be used if the positive peak of the audio frequency envelope does not exceed 115 per cent of the

Obtained preferably from a fixed supply, or from the plate supply voltage with a voltage divider.

carrier conditions.

Obtained from fixed supply, by grid-No.1 resistor, by cathode resistor, or by combination methods,

CHARACTERISTICS RANGE VALUES FOR EQUIPMENT DESIGN

	Note	Min.	Max.	
Heater Current	1	1.84	2.26	amp
Direct Interelectrode Capacitances:			-	
Grid No.1 to plate	2	-	0.065	$\mu\mu$ f
Grid No.1 to cathode & heater	2	11.8	15.2	$\mu\mu$ f
Plate to cathode & heater	2	-	0.015	μμf
Grid No.1 togrid No.2		15.9	18.9	μμf -
Grid No.2 to plate		4	5	μμf
Grid No.2 to cathode & heater	2	-	0.4	μμf
Grid-No.1 Voltage	1,3	-6	-15	volts-
Grid-No.1 Cutoff Voltage	1,4	-	-30	volts
Grid-No.1 Current	1,5	10		ma
Reverse Grid-No.1 Current	1,3	-	-20	μa
Grid-No.2 Current	1,3	-8	+2	ma.
Peak Emission Voltage	1,6	_	400	volts
Interelectrode Leakage Resistance	7	1	_	megohm
Useful Power Output		80	-	watts
		🖚 Ine	dicates a	change.

Note 1: With 6.3 volts ac or dc on heater.

Note 2: Measured with special shield adapter.

Note 3: With dc plate voltage of 1000 volts, dc grid-No.2 voltage of 300 volts, and dc grid-No.1 voltage adjusted to give a dc plate current of 115 ma.

Note 4: With dc plate voltage of 1000 volts, dc grid-No.2 voltage of 250 volts, and dc grid-No.1 voltage adjusted to give a dc plate current of 1 ma.

Note 5: With plate and grid-No.2 floating and dc grid-No.1 voltage of #7 volts.

Note 6: For conditions with: grid No.1, grid No.2, and plate tied together; and pulse-voltage source connected between plate and cathode. Pulse duration is 2 microseconds, pulse-repetition frequency is 60 pps, and duty factor is 0.00012. The voltage-pulse amplitude is adjusted until a peak cathode current of 10 amperes is obtained. After 1 minute at this value, the voltage-pulse amplitude will not exceed 400 volts (peak).

pulse ampiritude will not exceed 400 volts (peak).

Note 7: Under conditions with tube at 20° to 30° C for at least 30 minutes without any voltages applied to the tube. The minimum resistance between any two adjacent electrodes as measured with a 200-volt Megger-type chameter having an internal impedance of 1 megohm, will be 1 megohm.

Note 8: In a single-tube, grid-driven, coaxial-cavity class-C-amplifier circuit at 400 Mc and for conditions with 5.7 volts ac or dc on heater, dc plate voltage of 100 volts, dc grid-Mo.2 voltage of 300 volts, grid-No.1 resistor adjustable between 1000 and 10,000 ohms, dc plate current of 180 ma. maximum, dc grid-No.1 current of 20 ma. maximum, and driver power output of 3 watts.

COOLING CONSIDERATIONS

The conduction-cooling system consists, in general, of a constant-temperature device (heat sink) and suitable heat-flow path (coupling) between the heat sink and tube. Careful consideration should be given to the design of a heat-flow path through a coupling device having low electrical conductivity and high thermal conductivity.

The maximum plate dissipation may be calculated from the equation:

$$W = KA \frac{(T_2 - T_1)}{L}$$

where:

W = maximum plate dissipation in watts

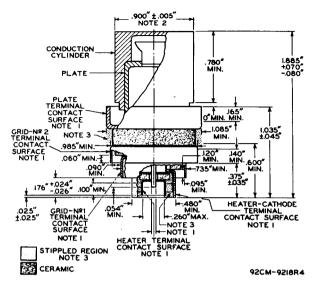
 $K = thermal conductivity \spadesuit of the coupling material$

A = area measured at right angles to the direction of the flow of heat in square inches

 T_2, T_1 = temperature in degrees Centigrade of planes or surfaces under consideration

L = length of heat path in inches through coupling material to produce temperature gradient

★ Thermal conductivity is defined as the time rate of transfer of heat by conduction, through unit thickness, across unit area for unit difference of temperature. It is measured in watts per square inch for a thickness of one inch and a difference of temperature of 1°C.

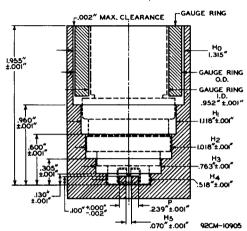


NOTE 1: WITH THE CYLINDRICAL SURFACES OF THE PLATE TERMINAL, GRID-NO.2 TERMINAL, GRID-NO.1 TERMINAL, HEATER-CATHODE TERMINAL, AND HEATER TERMINAL CLEAN, SMOOTH, AND FREE OF BURRS, THE TUBE WILL ENTER A GAUGE AS SHOWN IN SKETCH G1. THE TUBE IS PROPERLY SEATED IN THE GAUGE WHEN A 0.010"-THICKNESS GAUGE 1/8" WIDE WILL NOT ENTER BETWEEN THE HEATER-CATHODE TERMINAL AND THE BOTTOM SURFACE OF H4. THE GAUGE IS PROVIDED WITH A SLOT TO PERMIT MAKING MEASUREMENT OF SEATING OF HEATER-CATHODE TERMINAL ON BOTTOM OF HOLE H4.

NOTE 2: WITH THE TUBE SEATED IN GAUGE AND WITH THE CON-DUCTION CYLINDER CLEAN, SMOOTH, AND FREE OF BURRS, THE GAUGE RING WILL SLIP OVER CONDUCTION CYLINDER AS SHOWN IN SKETCH G₁.

NOTE 3: KEEP ALL STIPPLED REGIONS CLEAR. DO NOT ALLOW CONTACTS OR CIRCUIT COMPONENTS TO PROTRUDE INTO THESE ANNULAR VOLUMES.

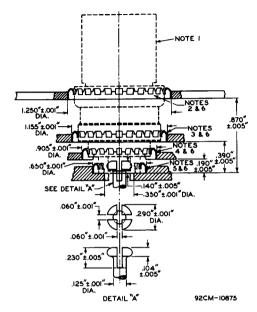
SKETCH GI



THE AXES OF THE CYLINDRICAL HOLES $\rm H_1$ THROUGH $\rm H_5$ AND THE AXIS OF POST P ARE COINCIDENT WITHIN 0.001".

THE AXES OF THE GAUGE-RING INSIDE DIAMETER AND GAUGE-RING OUTSIDE DIAMETER ARE COINCIDENT WITHIN 0.001".

SUGGESTED MOUNTING ARRANGEMENT & LAYOUT OF ASSOCIATED CONTACTS



IF A CLAMP IS USED, IT MUST BE ADJUSTABLE IN A PLANE NORMAL TO THE MAJOR TUBE AXIS TO COMPENSATE FOR VARIATIONS INCONCENTRICITY BETWEEN THE CONDUCTION CYLINDER AND THE CONTACT TERMINALS.

NOTE 2: CONTACT RING No. 97-252 OR FINGER STOCK No. 97-380.

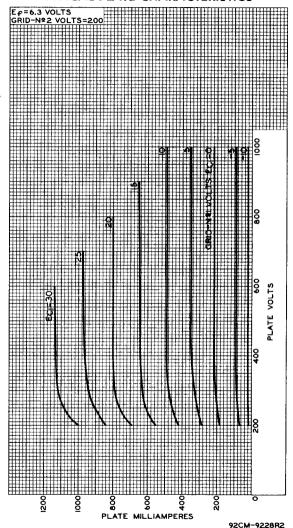
NOTE 3: CONTACT RING No. 97-253 OR FINGER STOCK No. 97-380.

NOTE 4: CONTACT RING No. 97-254 OR FINGER STOCK No. 97-380.

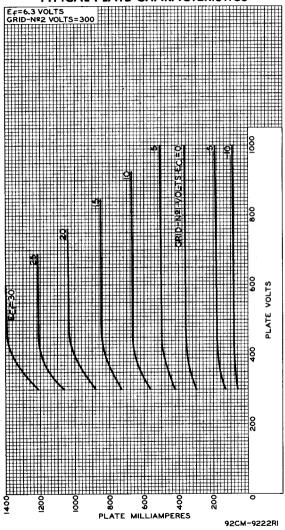
NOTE 5: CONTACT RING No. 97-255 OR FINGER STOCK No. 97-380.

NOTE 6: THE SPECIFIED CONTACT RING OF PREFORMED FINGER STOCK AND FINGER STOCK No.97-380 PROVIDE ADEQUATE ELEC-TRICAL CONTACT, BUT THE FINGER STOCK No. 97-380 IS LESS SUSCEPTIBLE TO BREAKAGE THAN THE SPECIFIED CONTACT RING. BOTH TYPES ARE MADE BY INSTRUMENTS SPECIALTIES COMPANY. LITTLE FALLS, NEW JERSEY.

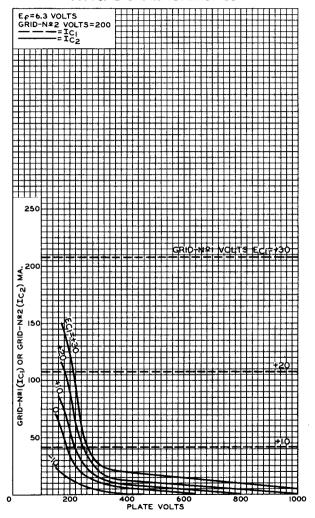
TYPICAL PLATE CHARACTERISTICS



TYPICAL PLATE CHARACTERISTICS

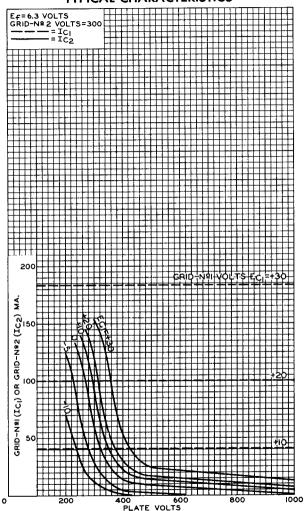


TYPICAL CHARACTERISTICS



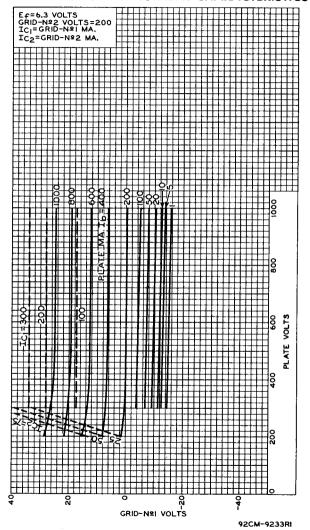
92CM-9224RI

TYPICAL CHARACTERISTICS

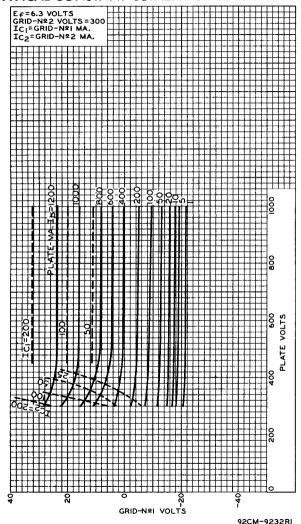


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TYPICAL CONSTANT-CURRENT CHARACTERISTICS

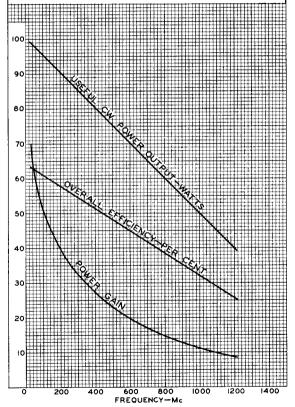


TYPICAL CONSTANT-CURRENT CHARACTERISTICS



TYPICAL PERFORMANCE CHARACTERISTICS In Class C Telegraphy or Class C FM Telephony Amplifier Service

F=ADJUSTED TO SIMULATE NORMAL OPERATING CONDITIONS OF HEATER IN UHF SERVICE PLATE VOLTS = 900 GRID-Nº2 VOLTS = 300 PLATE AMPERES = 0.170 OVERALL EFFICIENCY = USEFUL POWER OUTPUT IN LOAD
DIVIDED BY DC PLATE INPUT
POWER GAIN=USEFUL POWER OUTPUT IN LOAD DRIVER POWER OUTPUT



92CM - 922I